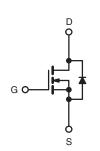


## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.20			
Q <sub>g</sub> (Max.) (nC)	11				
Q <sub>gs</sub> (nC)	3.1				
Q <sub>gd</sub> (nC)	5.8				
Configuration	Single				





N-Channel MOSFET

### **FEATURES**

- Dynamic dV/dt Rating
- For Automatic Insertion
- End Stackable
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD014PbF		
Lead (FD)-life	SiHFD014-E3		
SnPb	IRFD014		
SIFD	SiHFD014		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	60	.,	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	1.7	A	
Continuous Drain Current		T <sub>A</sub> = 100 °C		1.2		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	14		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	130	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		P <sub>D</sub>	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	00	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 52 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 1.7 A (see fig. 12).
- c.  $I_{SD} \leq$  10 A,  $dI/dt \leq$  90 A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_{J} \leq$  175 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFD014, SiHFD014

# Vishay Siliconix



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	$R_{thJA}$	-	120	°C/W		

PARAMETER	SYMBOL	vise noted)  TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						l	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.063	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zon Oda Vallera Buria O mad	I <sub>DSS</sub>	V <sub>DS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 48 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.0 A <sup>b</sup>	-	-	0.20	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 25 V, I <sub>D</sub> = 1.0 A <sup>b</sup>	0.96	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V 0V		-	310	-	pF
Output Capacitance	Coss	]	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		160	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.			37	-	
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 48 \text{ V}$ see fig. 6 and 13 <sup>b</sup>	-	-	11	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	3.1	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	5.8	
Turn-On Delay Time	t <sub>d(on)</sub>			-	10	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $I_{D}$ = 10 A $R_{g}$ = 24 $\Omega$ , $R_{D}$ = 2.7 $\Omega$ , see fig. 10 <sup>b</sup>		-	50	-	ns ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	13	-	
Fall Time	t <sub>f</sub>			-	19	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.0	-	- LI
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.7	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	14	- A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 1.7 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 00 1	40.4 -11/-12 - 400.4 / 5	-	70	140	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 10  \text{A}, dI/dt = 100  \text{A/}\mu\text{s}^b$		-	0.20	0.40	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					L <sub>D</sub> )

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

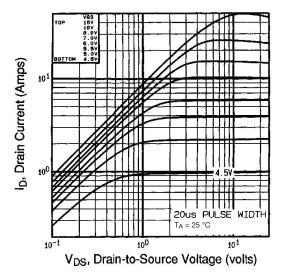


Fig. 1 - Typical Output Characteristics,  $T_A$  = 25 °C

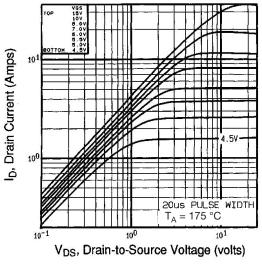


Fig. 2 - Typical Output Characteristics,  $T_A$  = 175 °C

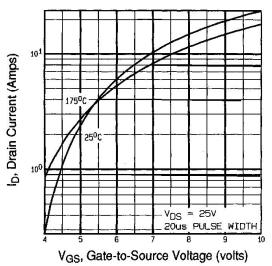


Fig. 3 - Typical Transfer Characteristics

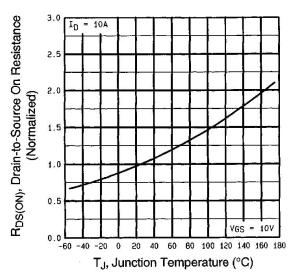


Fig. 4 - Normalized On-Resistance vs. Temperature



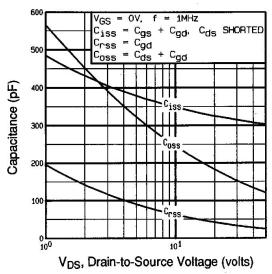


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

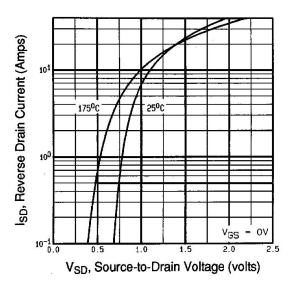


Fig. 7 - Typical Source-Drain Diode Forward Voltage

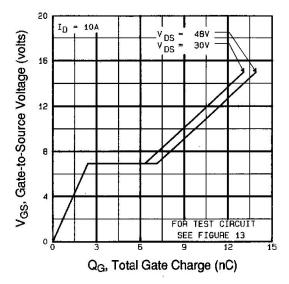


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

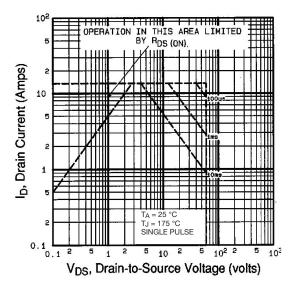


Fig. 8 - Maximum Safe Operating Area





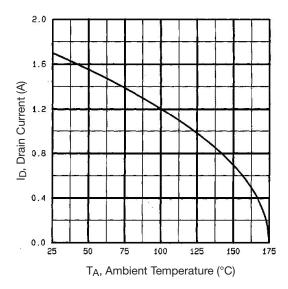


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

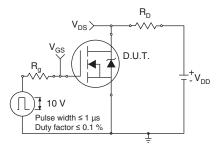


Fig. 10a - Switching Time Test Circuit

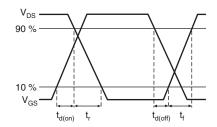


Fig. 10b - Switching Time Waveforms

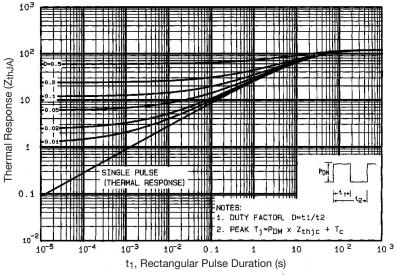
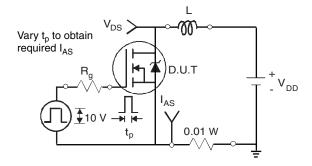


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient





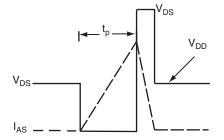


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

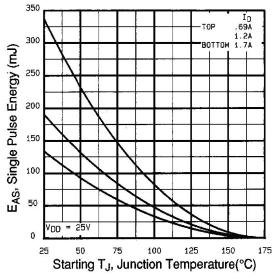


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

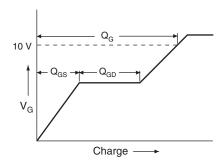


Fig. 13a - Basic Gate Charge Waveform

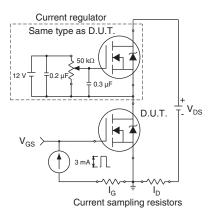
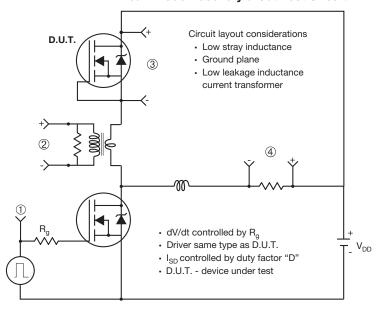


Fig. 13b - Gate Charge Test Circuit





### Peak Diode Recovery dV/dt Test Circuit



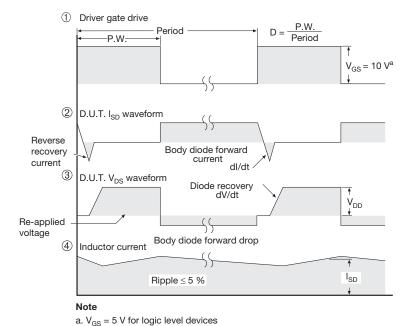
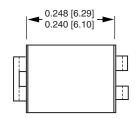
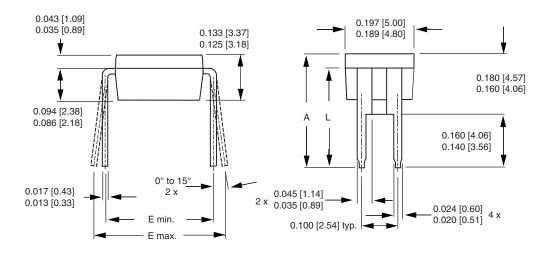


Fig. 14 - For N-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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